## mail

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



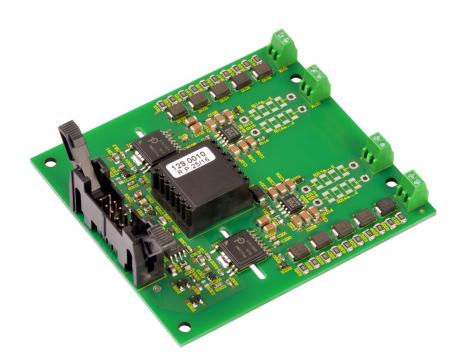
### Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# General Purpose Base Board for SCALE™-iDriver SID1182K with Booster Stage

Application	General purpose drives, UPS, solar power and others	
Specification	Suitable for IGBT power modules in various housings Up to 800V DC-link voltage Electrical interfaces Basic Active Clamping Short-circuit detection with Advanced Soft Shut Down	
Author High-Power Application Engineering Department		
Document Number RDHP-1526		
<b>Revision</b> <sup>1</sup>	A.1	



<sup>&</sup>lt;sup>1</sup> The letter refers to the hardware revision. The number refers to the documentation revision.



#### Scope

This application proposal provides a circuit design for a general purpose base board for driving various IGBT power modules.

The main features of the design are:

- Suitable for IGBT power modules in various housings such as 17mm dual, 17mm six-pack, 62mm, PrimePACK<sup>™</sup>, etc. with a maximum blocking voltage of 1200V
- Basic Active Clamping
- Short-circuit detection with Advanced Soft Shut Down (ASSD)
- External booster stage
- Electrical command inputs and status outputs
- 0V/5V command input logic
- 0V/5V status output logic
- Minimum pulse suppression
- 5V supply voltage
- Single PCB solution with soldered-in gate driver IC

#### Intellectual Property Licensing

The design proposal, products and applications illustrated herein (including transformer construction and circuits external to the products) may be covered by one or more U.S. and foreign patents, or potentially by pending U.S. and foreign patent applications assigned to Power Integrations.

A complete list of Power Integrations patents may be found at <u>https://www.power.com/</u>.

Power Integrations grants its customers a license under certain patent rights as set forth at <u>https://www.power.com/company/intellectual-property-licensing/</u>.

#### **Application Conditions**

The design is proposed for the following application conditions:

- General purpose applications and IGBT power modules
- Adaptations such as adjustment of gate resistors can easily be done



#### Design Description

In addition to the following design description, reference to the datasheet of the SID1182K gate driver IC family is recommended.

#### Gate Resistors

Gate resistor values are not explicitly given as they depend on the IGBT power module used and on the application. Gate resistors of either SMD (size 1206) or THT (size PR02) package can be selected.

Turn-on gate resistors:

Channel	SMD Package	THT Package
1	R114a R114d	R113
2	R214a R214d	R213

Turn-off gate resistors:

Channel	SMD Package	THT Package
1	R116a R116d	R115
2	R216a R216d	R215

The gate resistors must be determined and assembled by the user.

#### V<sub>CEsat</sub> Monitoring

SID1182K gate driver ICs from Power Integrations provide sense inputs for monitoring IGBT short-circuit conditions. The details of the  $V_{CEsat}$  monitoring function are described in the corresponding datasheet of the gate driver.

#### Advanced Soft Shut Down (ASSD)

The driver ICs SID1182K of the SCALE-iDriver family feature an Advanced Soft Shut Down (ASSD) function, which reduces the turn-off  $^{di}/_{dt}$  to limit  $V_{CE}$  overvoltage spikes as soon as a short-circuit condition is detected. An excessive turn-off overvoltage is therefore avoided and the IGBT is turned off within its safe operating area.

The ASSD function is only active under short-circuit conditions, but not under normal operating conditions (e.g. at nominal current or in over-current conditions), i.e. it is triggered by the  $V_{CEsat}$  monitoring function.

The ASSD function may also have performance limitations, such as at high DC-link voltages and/or high commutation loop stray inductances. If the application is operated at these boundary conditions, it is recommended to implement Basic Active Clamping.

For further details concerning the ASSD function refer to the datasheet of the gate driver IC SID1182K.

#### **Basic Active Clamping**

Active clamping is a technique designed to partially turn on the IGBT in case the collector-emitter voltage exceeds a predefined threshold. The IGBT is then kept in linear operation. Basic Active Clamping topologies



implement a single feedback path from the IGBT's collector through transient voltage suppressor (TVS) diodes to the IGBT gate.

Basic Active Clamping is recommended as an option in addition to the Advanced Soft Shut Down (ASSD) function in the following cases depending on actual application conditions:

- High DC-link voltage and/or high commutation loop stray inductances
- Turning-off overcurrents and/or high commutation loop stray inductances

#### **Minimum Pulse Suppression**

This design possesses a minimum pulse suppression with a time constant  $\tau$  of typically 99ns. If required the setting can be changed by adjusting C300 and C301. The time constant  $\tau$  is given by the following equations:

 $\tau_1 = 99\Omega \cdot C300$ 

 $\tau_2 = 99\Omega \cdot C301$ 

Recommended values of C300 and C301 are in the range of 1nF ( $\tau_x$  = 99ns) to 3.3nF ( $\tau_x$  = 327ns), depending on actual application conditions.

#### **Blocking Time**

During the blocking time, which is set to typically 10µs, the gate driver IC ignores incoming command signals. The blocking time starts once a fault was detected by the gate driver IC's secondary side (undervoltage lockout or a short-circuit event) or when an undervoltage condition ends on the primary side.

For further details refer to the datasheet of the gate driver SID1182K.

#### Interfaces

#### **Electrical Interfaces**

X300		
Pin	Designation	Description
1	V5	5V supply (referenced to GND)
3	SO2	Status output channel 2
5	INB	Command input channel 2
7	SO1	Status output channel 1
9	INA	Command input channel 1

X300		
Pin	Designation	Description
2	GND	Ground
4	GND	Ground
6	GND	Ground
8	GND	Ground
10	GND	Ground

X100		
Pin	Designation	Description
1	E1	Emitter channel 1
2	G1	Gate channel 1

X101		
Pin	Designation	Description
1	C1	Collector channel 1
2	C1	Collector channel 1

X200		
Pin	Designation	Description
1	G2	Gate channel 2
2	E2	Emitter channel 2

X201		
Pin	Designation	Description
1	C2	Collector channel 2
2	C2	Collector channel 2

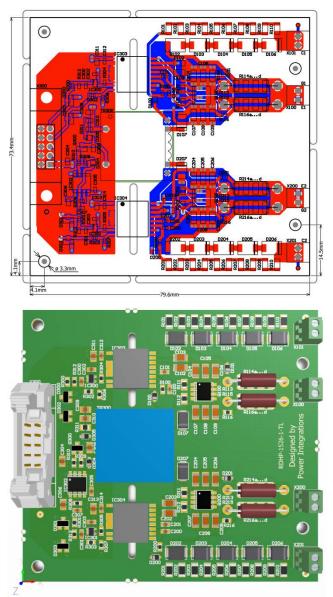


#### CAD Data

The set of CAD data, which includes the circuit schematics, Gerber files, BOM and Pick-and-Place file are available as separate documents bundled together with this documentation.

#### Layout Example

An example for a suitable layout is shown in the following picture. The recommended PCB thickness is 1.55mm.





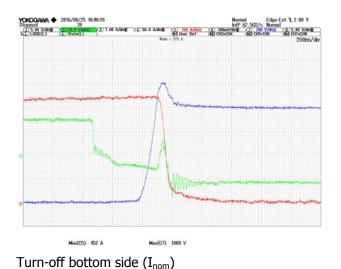
#### **Switching Characteristic**

#### Turn-On/ Off

The measurement examples shown with the IGBT power module FF450R12KT4 from Infineon Technologies ( $R_{Gon} = 1\Omega$  and  $R_{Goff} = 1\Omega$ ) were carried out in a double-pulse test using a half-bridge topology setup at room temperature with an initial DC-link voltage of  $800V_{DC}$ . The adjusted load current is either 450A ( $I_{nom}$ ) or 900A (2x  $I_{nom}$ ).

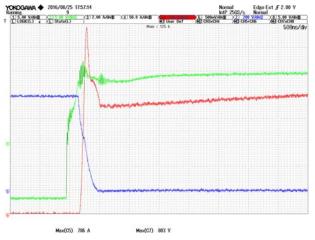
Channel assignment:

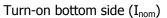
- Channel C2: Gate-emitter voltage
- Channel C5: Collector current
- Channel C7: Collector-emitter voltage

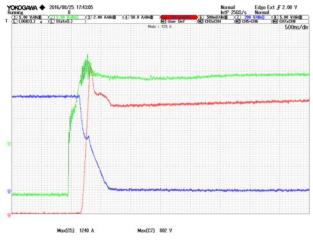




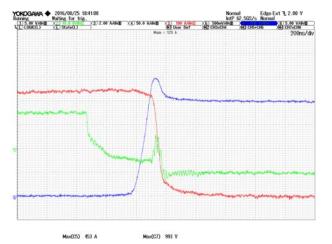
Turn-off bottom side (2x Inom)

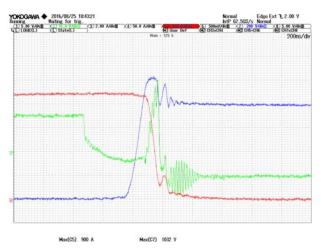




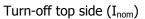


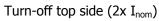
Turn-on bottom side (2x Inom)

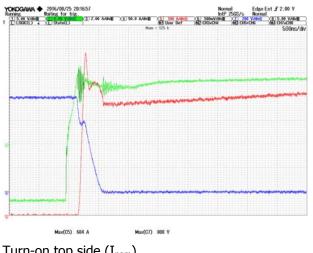


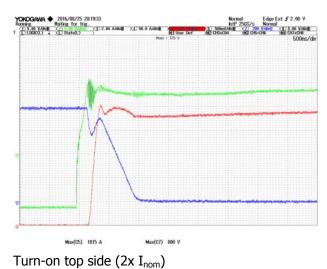


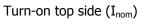
integrations"













#### Short-Circuit

The measurement examples shown with the IGBT power module FF450R12KT4 from Infineon Technologies ( $R_{Gon} = 1\Omega$  and  $R_{Goff} = 1\Omega$ ) were carried out at room temperature with an initial DC-link voltage of  $800V_{DC}$ .

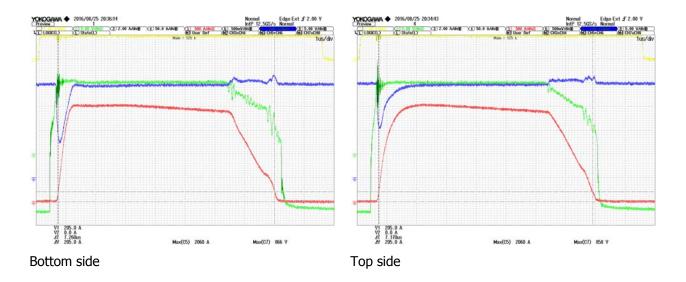
Channel assignment:

Channel C1: Command input signal

Channel C5: Collector current

Channel C2: Gate-emitter voltage

Channel C7: Collector-emitter voltage





#### Handling

To avoid possible failures caused by ESD, a handling- and assembly-process with persistent ESD protection is necessary /2/.

#### References

- /1/ SID11x2K SCALE-iDriver Family Data Sheet, Power Integrations
- /2/ Application Note AN-0902, "Avoiding ESD with CONCEPT Drivers", Power Integrations

#### **Technical Support**

Power Integrations provides expert help with your questions and problems:

Website <u>http://www.power.com/iqbt-driver/qo/support</u>

Email <u>igbt-driver.support@power.com</u>

#### Quality

The obligation to high quality is one of the central features laid down in the mission statement of Power Integrations. Our total quality management system assures state-of-the-art processes throughout all functions of the company, certified by ISO9001:2008 standards.

#### Legal Disclaimer

Reference Designs are technical proposals concerning how to use Power Integrations' gate drivers in particular applications and/or with certain power modules. These proposals are "as is" and are not subject to any qualification process. The suitability, implementation and qualification are the sole responsibility of the end user.

The statements, technical information and recommendations contained herein are believed to be accurate as of the date hereof. All parameters, numbers, values and other technical data included in the technical information were calculated and determined to our best knowledge in accordance with the relevant technical norms (if any). They may base on assumptions or operational conditions that do not necessarily apply in general. We exclude any representation or warranty, express or implied, in relation to the accuracy or completeness of the statements, technical information and recommendations contained herein. No responsibility is accepted for the accuracy or sufficiency of any of the statements, technical information, recommendations or opinions communicated and any liability for any direct, indirect or consequential loss or damage suffered by any person arising therefrom is expressly disclaimed.



#### **Power Integrations Sales Offices**

#### WORLD HEADQUARTERS

5245 Hellyer Avenue San Jose, CA 95138 USA Tel: +1-408-414-9200 Fax: +1-408-414-9765 Email: <u>usasales@power.com</u>

#### AMERI CAS WEST

5245 Hellyer Avenue San Jose, CA 95138 USA Tel: +1-408-414-8778 Fax: +1-408-414-3760 Email: <u>usasales@power.com</u>

#### GERMANY (AC-DC/LED Sales)

Lindwurmstrasse 114 80337 München, Germany Tel: +49-89-5527-39100 Fax: +49-89-1228-5374 Email: <u>eurosales@power.com</u>

#### INDIA (Mumbai)

Unit: 106-107, Sagar Tech Plaza-B Sakinaka, Andheri Kurla Road Mumbai, Maharashtra 400072 India Tel 1: +91-22-4003-3700 Tel 2: +91-22-4003-3600 Email: <u>indiasales@power.com</u>

#### JAPAN

Kosei Dai-3 Bldg. 2-12-11, Shin-Yokohama, Kohoku-ku Yokohama-shi, Kanagawa Japan 222-0033 Tel: +81-45-471-1021 Fax: +81-45-471-3717 Email: japansales@power.com

#### TAI WAN

5F, No. 318, Nei Hu Rd., Sec. 1 Nei Hu Dist. Taipei, 114 Taiwan Tel: +886-2-2659-4570 Fax: +886-2-2659-4550 Email: taiwansales@power.com

#### AMERI CAS EAST

7360 McGinnis Ferry Road Suite 225 Suwannee, GA 30024 USA Tel: +1-678-957-0724 Fax: +1-678-957-0784 Email: usasales@power.com

CHINA (Shanghai)

Room 2410, Charity Plaza No. 88 North Caoxi Road Shanghai, 200030 China Tel: +86-21-6354-6323 Fax: +86-21-6354-6325 Email: <u>chinasales@power.com</u>

**GERMANY** (IGBT Driver Sales) HellwegForum 1 59469 Ense, Germany Tel: +49-2938-64-39990 Email: <u>igbt-driver.sales@power.com</u>

I NDI A (New Dehli) #45, Top Floor Okhla Industrial Area, Phase - III New Dehli, 110020 India Tel 1: +91-11-4055-2351 Tel 2: +91-11-4055-2353 Email: indiasales@power.com

#### KOREA

RM602, 6FL, 22 Teheran-ro 87-gil, Gangnam-gu Seoul, 06164 Korea Tel: +82-2-2016-6610 Fax: +82-2-2016-6630 Email: <u>koreasales@power.com</u>

#### UNI TED KI NGDOM

Bulding 5, Suite 21 The Westbrook Centre Milton Road Cambridge, CB4 1YG United Kingdom Tel: +44-7823-557-484 Email: <u>eurosales@power.com</u>

#### AMERI CAS CENTRAL

333 Sheridan Road Winnetka, IL 60093 USA Tel: +1-847-721-6293 Email: <u>usasales@power.com</u>

CHI NA (Shenzhen) 17/F, Hivac Building, No 2 Keji South 8th Road, Nanshan District Shenzhen, 518057 China Tel: +86-755-8672-8689 Fax: +86-755-8672-8690 Email: <u>chinasales@power.com</u>

#### INDIA (Bangalore)

#1, 14th Main Road Vasanthangar Bangalore, 560052 India Tel 1: +91-80-4113-8020 Tel 2: +91-80-4113-8028 Fax: +91-80-4113-8023 Email: indiasales@power.com

#### I TALY

Via Milanese 20 20099 Sesto San Giovanni (MI), Italy Tel: +39-02-4550-8708 Email: <u>eurosales@power.com</u>

#### **SI NGAPORE**

51 Newton Road #19-01/05 Goldhill Plaza Singapore, 308900 Tel 1: +65-6358-2160 Tel 2: +65-6358-4480 Fax: +65-6358-2015 Email: <u>singaporesales@power.com</u>